

# 2SK2902-01MR

# FUJI POWER MOS-FET

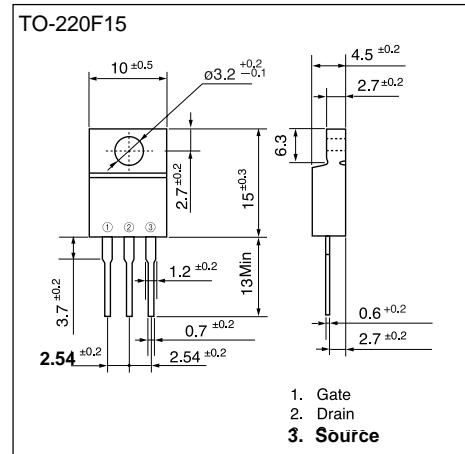
# N-CHANNEL SILICON POWER MOS-FET

## ■ Features

- High speed switching
  - Low on-resistance
  - No secondary breakdown
  - Low driving power
  - Avalanche-proof

## ■ Applications

- Switching regulators
  - UPS (Uninterruptible Power Supply)
  - DC-DC converters

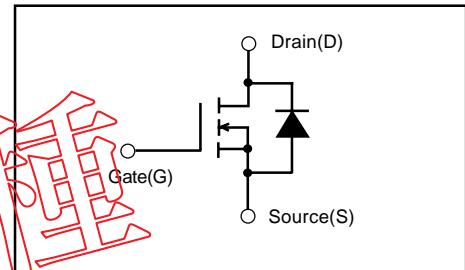


## ■ Maximum ratings and characteristicAbsolute maximum ratings

● (T<sub>c</sub>=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	V <sub>DS</sub>	60	V
Continuous drain current	I <sub>D</sub>	±45	A
Pulsed drain current	I <sub>D(puls)</sub>	±180	A
Gate-source voltage	V <sub>GS</sub>	±30	V
Maximum Avalanche Energy	E <sub>AV</sub> *1	461.9	J/m <sup>2</sup>
Max. power dissipation	P <sub>D</sub>	40	W
Operating and storage temperature range	T <sub>ch</sub> / T <sub>stg</sub>	-45 to +150	°C

## ■ Equivalent circuit schematic



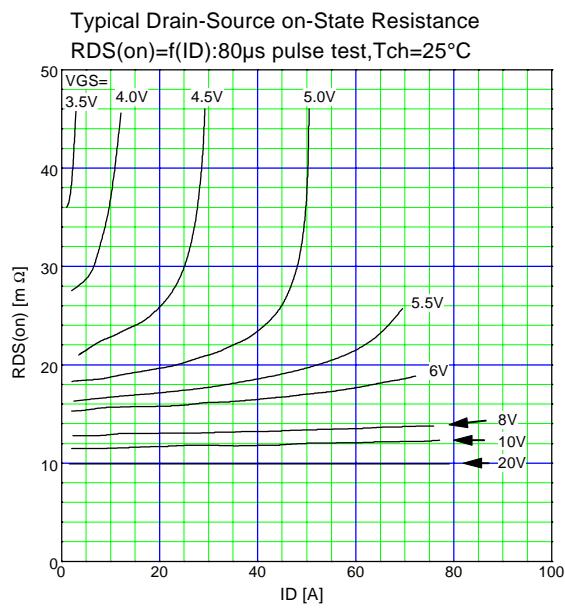
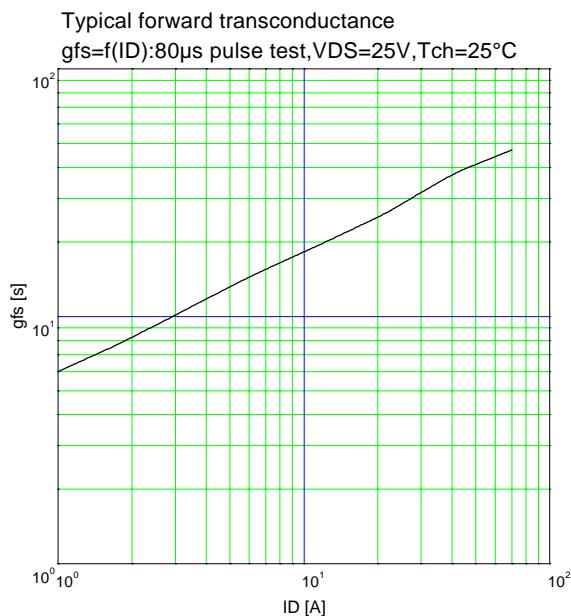
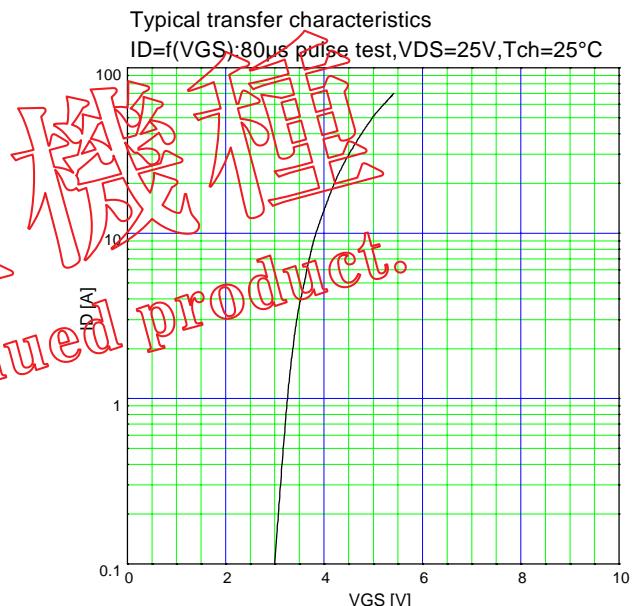
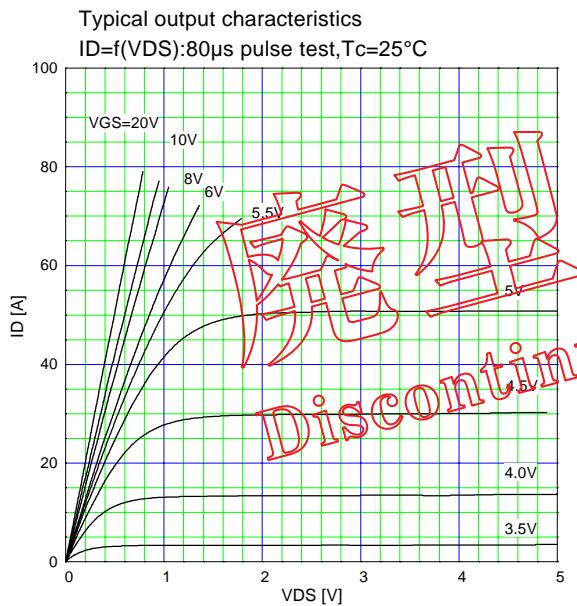
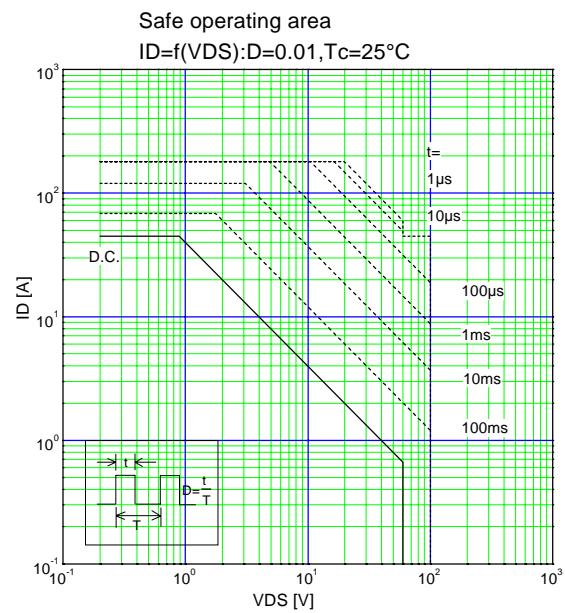
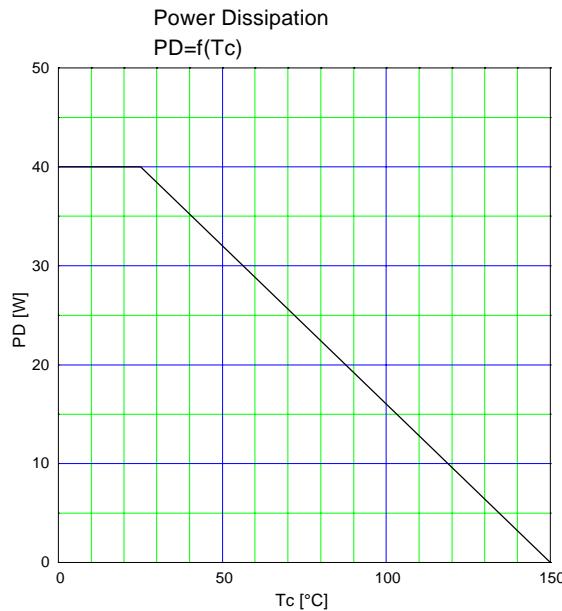
#### ● Electrical characteristics ( $T_c = 25^\circ\text{C}$ unless otherwise specified)

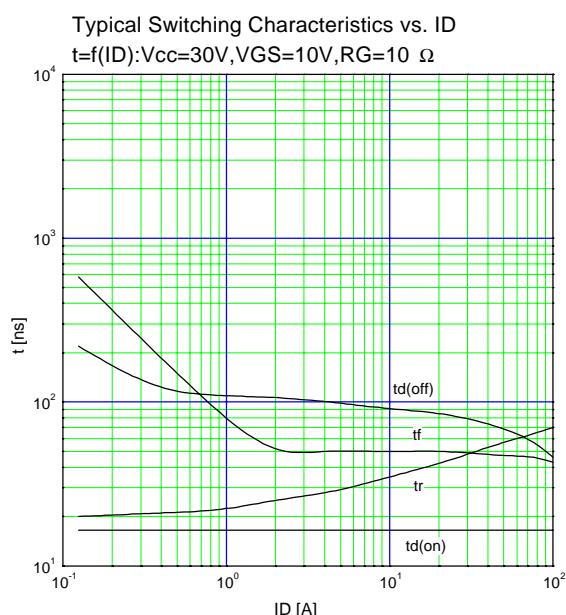
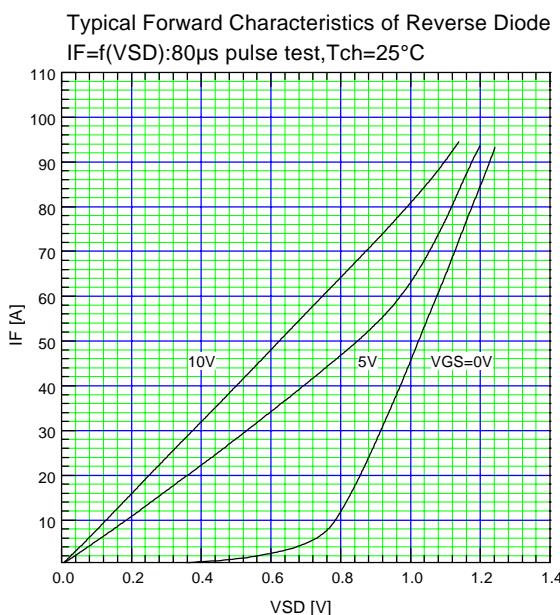
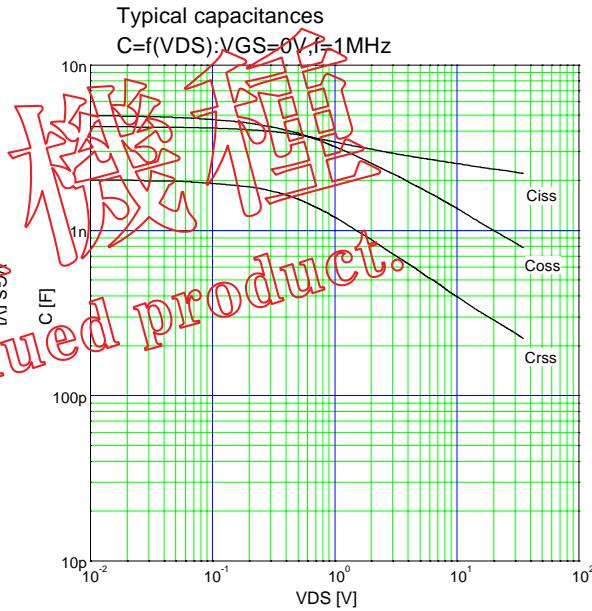
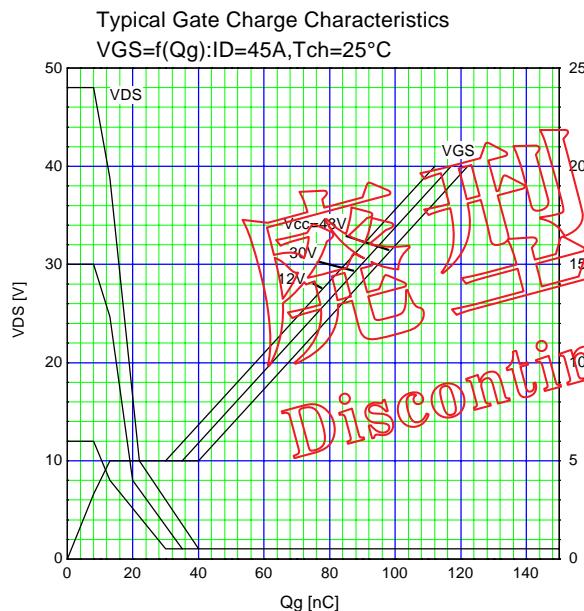
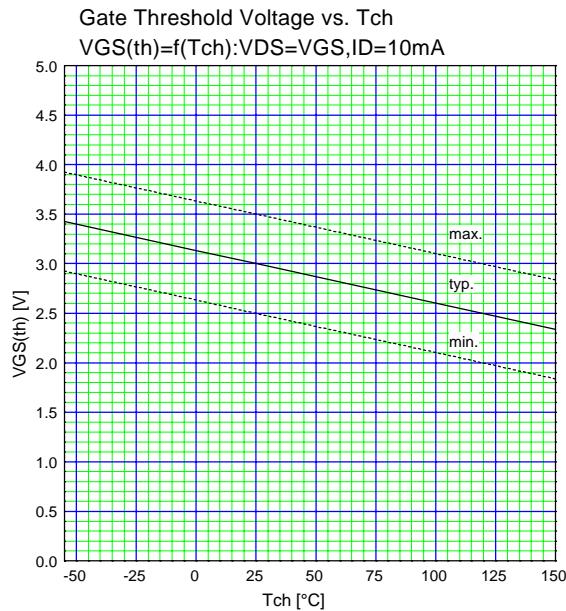
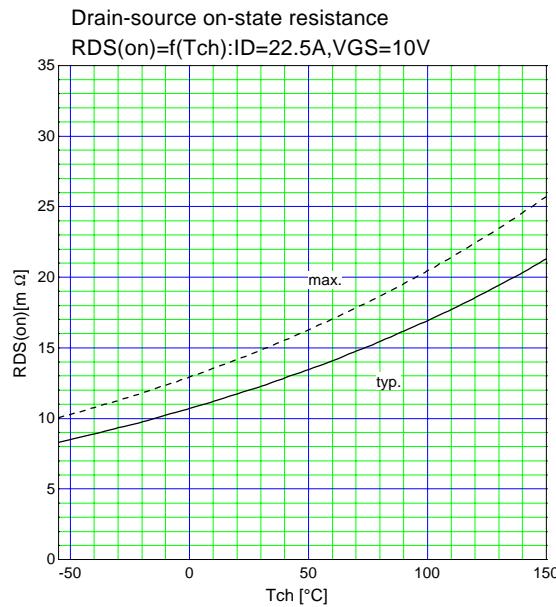
Item	Symbol	Test Conditions		Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> =1mA V <sub>GDS</sub> =0V		60			V
Gate threshold voltage	V <sub>G(th)</sub>	I <sub>D</sub> =10mA V <sub>DSS</sub> =V <sub>GDS</sub>		2.5	3.0	3.5	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DSS</sub> =60V V <sub>GDS</sub> =0V		T <sub>ch</sub> =25°C	10	500	µA
				T <sub>ch</sub> =125°C	0.2	1.0	mA
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GDS</sub> =±30V V <sub>DSS</sub> =0V			10	100	nA
Drain-source on-state resistance	R <sub>D(on)</sub>	I <sub>D</sub> =22.5A V <sub>GDS</sub> =10V			12.0	14.5	mΩ
Forward transconductance	g <sub>fs</sub>	I <sub>D</sub> =22.5A V <sub>DSS</sub> =25V		10.0	25.0		S
Input capacitance	C <sub>iss</sub>	V <sub>DSS</sub> =25V V <sub>GDS</sub> =0V f=1MHz			2300	3450	pF
Output capacitance	C <sub>oss</sub>				910	1370	
Reverse transfer capacitance	C <sub>rss</sub>				260	390	
Turn-on time t <sub>on</sub>	td(on)	V <sub>CC</sub> =30V I <sub>D</sub> =45A V <sub>GDS</sub> =10V			18	30	ns
	t <sub>r</sub>				55	80	
Turn-off time t <sub>off</sub>	td(off)				70	120	
	t <sub>f</sub>				48	80	
Avalanche capability	I <sub>AV</sub>	L=100 µH T <sub>ch</sub> =25°C		45			A
Diode forward on-voltage	V <sub>SD</sub>	I <sub>F</sub> =45A V <sub>GDS</sub> =0V T <sub>ch</sub> =25°C			1.0	1.5	V
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> =45A V <sub>GDS</sub> =0V			60		ns
Reverse recovery charge	Q <sub>rr</sub>	-di/dt=100A/us T <sub>ch</sub> =25°C			0.11		µC

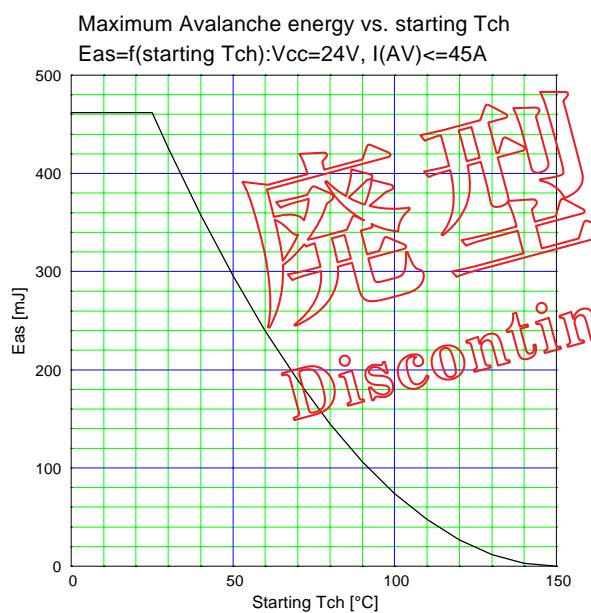
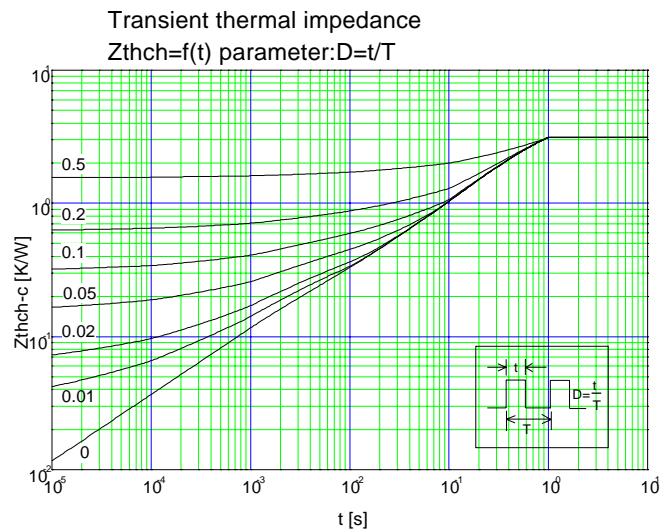
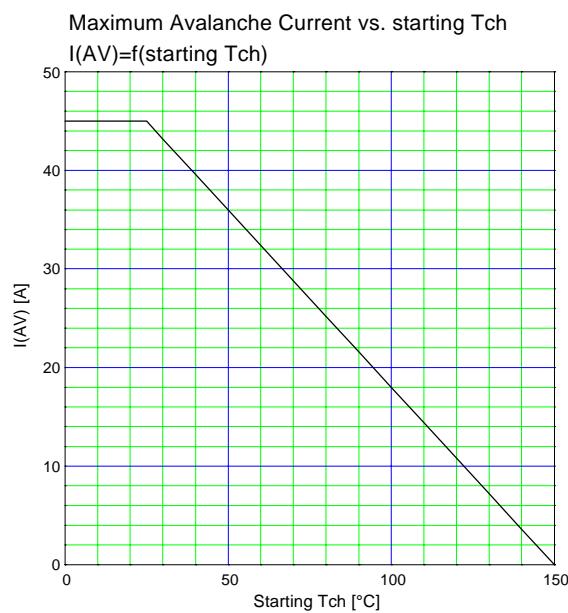
## ● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R <sub>th(ch-c)</sub>	channel to case			3.125	°C/W
	R <sub>th(ch-a)</sub>	channel to ambient			62.5	°C/W

## ■ Characteristics







機種

Discontinued product.